



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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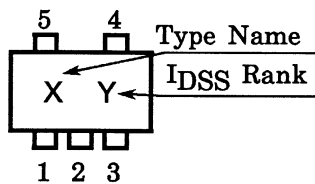


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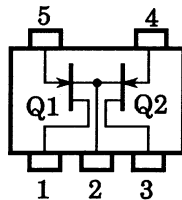
Audio Frequency Low Noise Amplifier Applications

- Including two devices in SM5 (super mini type with 5 leads.)
- High $|Y_{fs}|$: $|Y_{fs}| = 15 \text{ mS (typ.)}$ at $V_{DS} = 10 \text{ V}$, $V_{GS} = 0$
- High breakdown voltage: $V_{GDS} = -50 \text{ V}$
- Low noise: $NF = 1.0\text{dB (typ.)}$
at $V_{DS} = 10 \text{ V}$, $I_D = 0.5 \text{ mA}$, $f = 1 \text{ kHz}$, $R_g = 1 \text{ k}\Omega$
- High input impedance: $I_{GSS} = -1 \text{ nA (max)}$ at $V_{GS} = -30 \text{ V}$

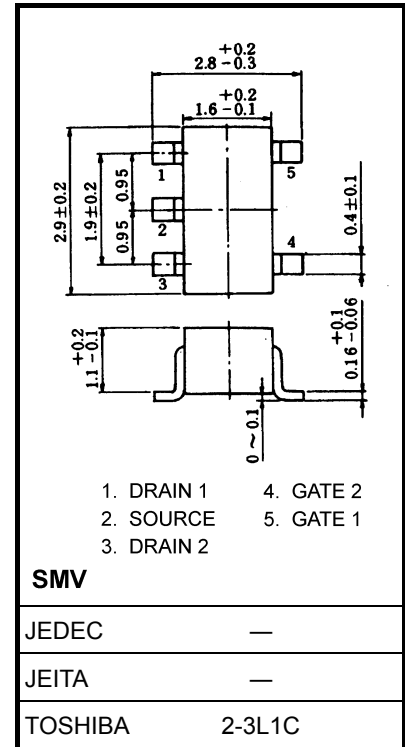
Marking



Pin Assignment (top view)



Unit: mm



Weight: 0.016 g (typ.)

Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 common)

Characteristics	Symbol	Rating	Unit
Gate-drain voltage	V_{GDS}	-50	V
Gate current	I_G	10	mA
Drain power dissipation	P_D (Note 1)	300	mW
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 to 125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating

Start of commercial production
1993-03

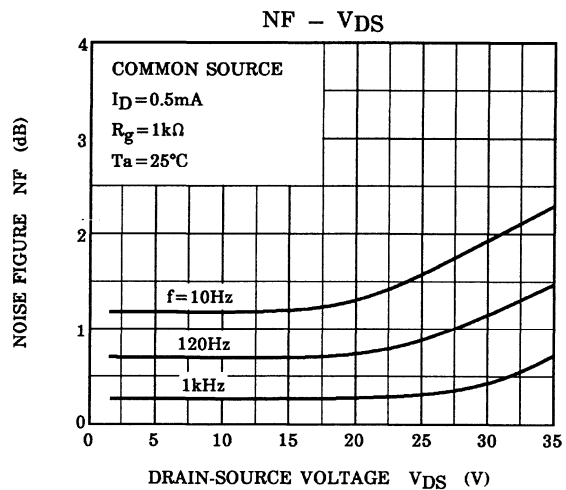
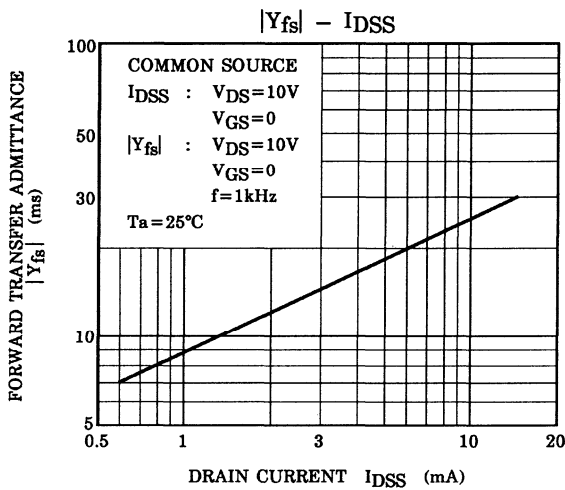
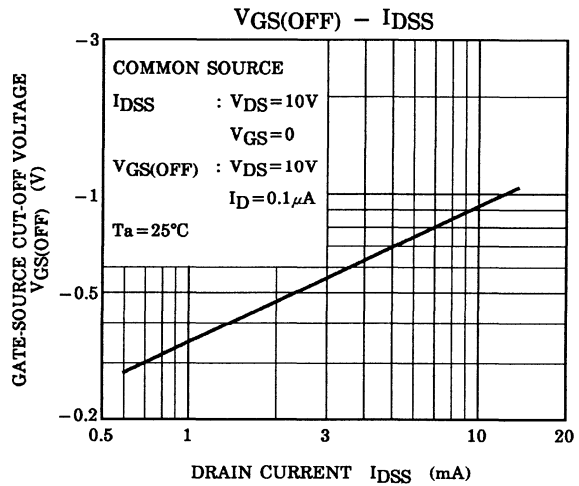
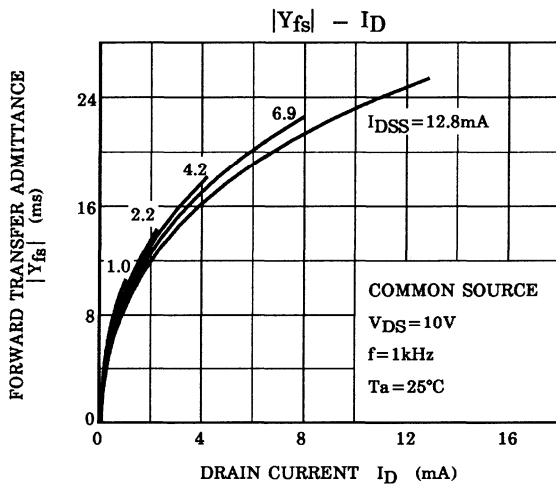
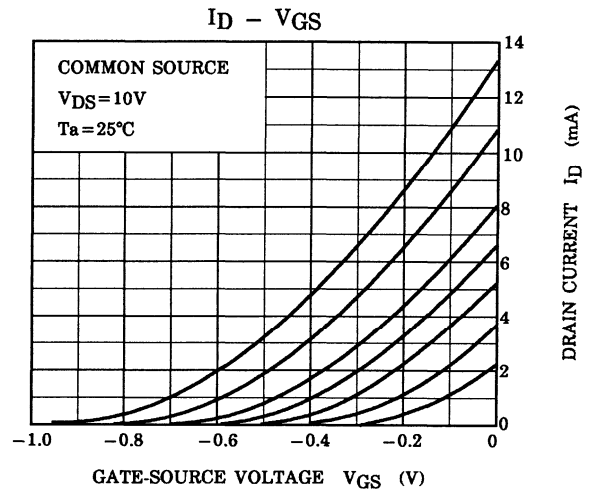
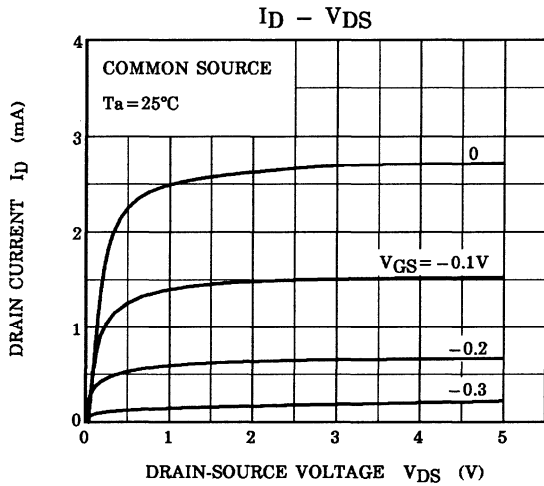
Electrical Characteristics (Ta = 25°C) (Q1, Q2 common)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate-leakage current	I_{GSS}	$V_{GS} = -30\text{ V}, V_{DS} = 0$	—	—	-1.0	nA
Gate-drain breakdown voltage	$V_{(BR)GDS}$	$V_{DS} = 0, I_G = -100\ \mu\text{A}$	-50	—	—	V
Drain current	I_{DSS} (Note 2)	$V_{DS} = 10\text{ V}, V_{GS} = 0$	1.2	—	14.0	mA
Gate-source cut-off voltage	$V_{GS(OFF)}$	$V_{DS} = 10\text{ V}, I_D = 0.1\ \mu\text{A}$	-0.2	—	-1.5	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 10\text{ V}, V_{GS} = 0, f = 1\text{ kHz}$	4.0	15	—	mS
Input capacitance	C_{iss}	$V_{DS} = 10\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$	—	13	—	pF
Reverse transfer capacitance	C_{rss}	$V_{DG} = 10\text{ V}, I_D = 0, f = 1\text{ MHz}$	—	3	—	pF
Noise figure	NF (1)	$V_{DS} = 10\text{ V}, R_g = 1\text{ k}\Omega$ $I_D = 0.5\text{ mA}, f = 10\text{ Hz}$	—	5	—	dB
	NF (2)	$V_{DS} = 10\text{ V}, R_g = 1\text{ k}\Omega$ $I_D = 0.5\text{ mA}, f = 1\text{ kHz}$	—	1	—	

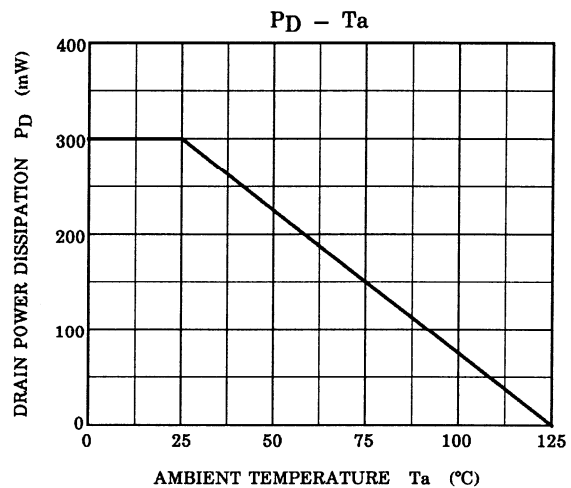
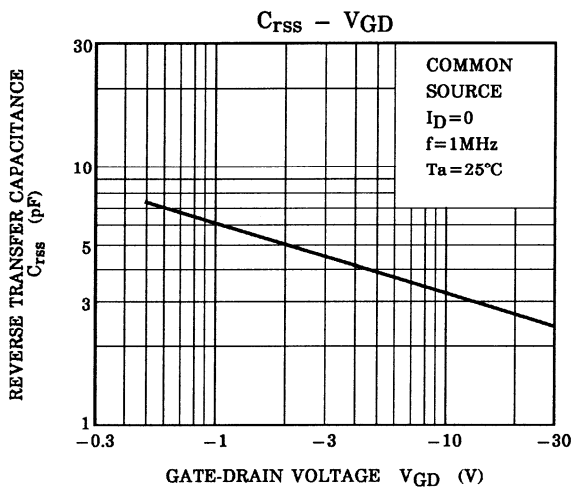
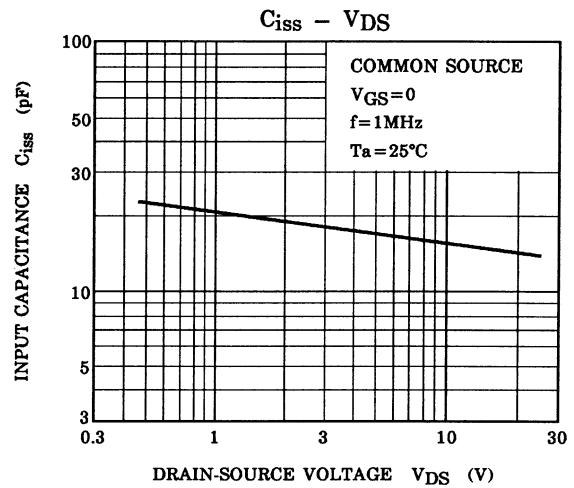
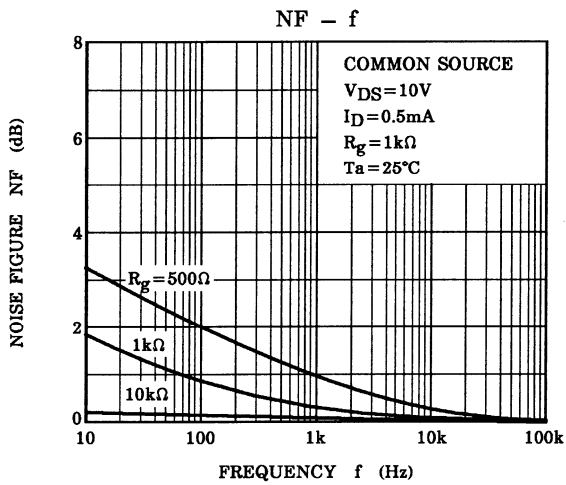
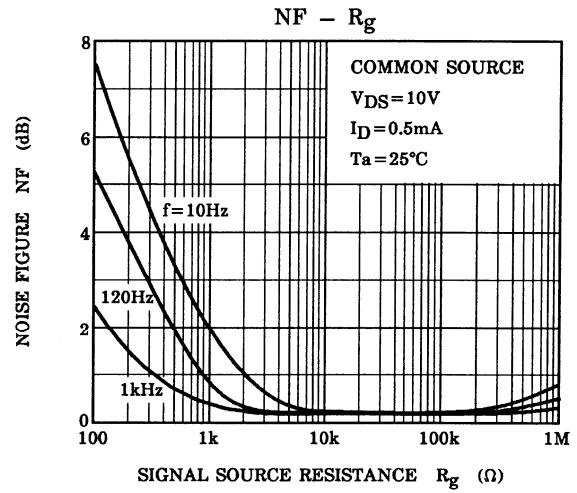
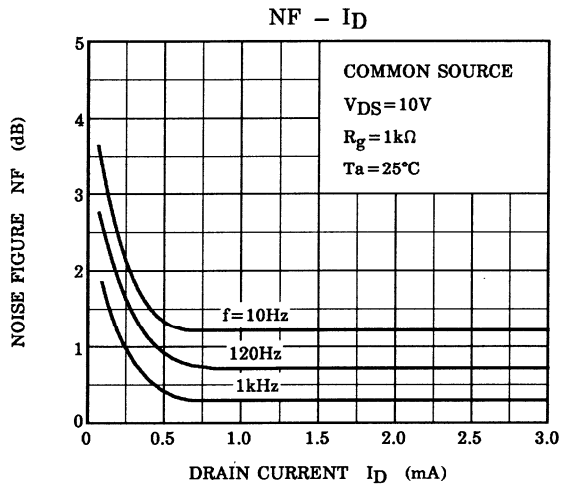
Note 2: I_{DSS} classification Y (Y): 1.2 to 3.0 mA, GR (G): 2.6 to 6.5 mA, BL (L): 6.0 to 14.0 mA

() Marking symbol

(Q1, Q2 common)



(Q1, Q2 common)



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